PROJEK BEVICES

SLVDA2.8LC

SUBMINATURE LOW CAPACITANCE TVS ARRAY

APPLICATIONS

- ✓ Ethernet 10/100 Base T
- ✔ Cellular Phone Base Stations
- ✓ Switching Stations
- ✓ Video Inputs
- ✔ PC Servers
- ✓ Handheld Electronic Equipment

IEC COMPATIBILITY (EN61000-4)

- ✓ 61000-4-2 (ESD): Air 15kv, Contact 8kv
- ✓ 61000-4-4 (EFT): 40A 5/50ns
- ✓ 61000-4-5 (Surge): 24A (t_n= 8/20µs)

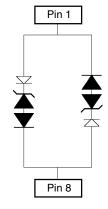
FEATURES

- ✓ 600 Watt Peak Pulse Power Dissipation at (t = 8/20µs)
- ✔ Provides Protection For Two Line Pairs
- **✓ LOW STANDBY CURRENT < 1.0µA**
- **✓ LOW CAPACITANCE 5pF PER DIODE**

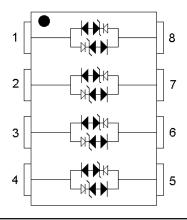
MECHANICAL CHARACTERISTICS

- ✓ Molded JEDEC SOIC-8 Package
- ✓ Weight 66 Milligrams (Approximate)
- ✓ Flammability Rating UL 94V-0
- ✓ Tape and Reel Per EIA Standard 481-1-A
- ✓ Marking: Device Marking Code, Pin 1 Marked with DOT & Date Code

CIRCUIT DIAGRAM



PIN CONFIGURATION



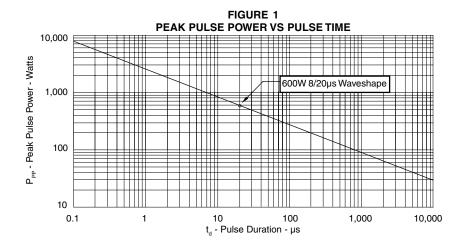


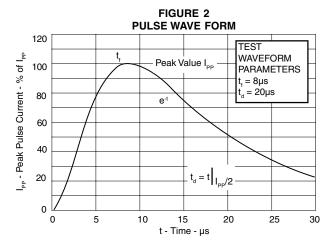
DEVICE CHARACTERISTICS

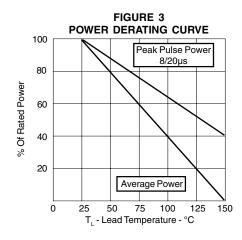
| MAXIMUM RATINGS @ 25°C Unless Otherwise Specified | | | | | | |
|---|------------------|----------------|-------|--|--|--|
| PARAMETER | SYMBOL | VALUE | UNITS | | | |
| Peak Pulse Power (t _p = 8/20µs) - See Figure 1 | P _{PK} | 600 | Watts | | | |
| Peak Pulse Current (t _p = 8/20μs) | I _{PP} | 24 | Α | | | |
| Lead Soldering Temperature | T _{II} | 260°C (10 Sec) | °C | | | |
| Operating Temperature | T_{J} | -55°C to 150°C | °C | | | |
| Storage Temperature | T _{STG} | -55°C to 150°C | °C | | | |

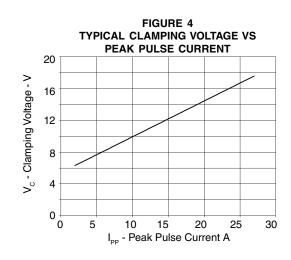
| ELECTRICAL CHARACTERISTICS PER LINE @ 25°C Unless Otherwise Specified | | | | | | | | | |
|---|---------------------------|--|---|---|--|--|---|---|-----------------------------------|
| PART NUMBER | DEVICE MARKING CODE | REVERSE STAND-OFF VOLTAGE V _{WM} | PUNCH THROUGH VOLTAGE V _{PT} I _{PT} = 2µA | SNAP BACK VOLTAGE $V_{\rm SB}$ $I_{\rm SB} = 50 \rm mA$ | CLAMPING VOLTAGE V _C @ 1 Amp 8/20µs | CLAMPING VOLTAGE V _C @ 5 Amp 8/20µs | CLAMPING VOLTAGE V _c @ 30 Amp 8/20µs | REVERSE LEAKAGE CURRENNT I _D V _{RWM} = 2.8V | CAPACITANCE (f = 1MHz) @ 0V |
| | | VOLTS | VOLTS | VOLTS | VOLTS | VOLTS | VOLTS | μΑ | pF |
| | | MAX | MIN | MIN | MAX | MAX | MAX | MAX | TYP |
| SLVU2.8LC | LV2.8 | 2.8 | 3.0 | 2.8 | 4.6 | 6.2 | 21 | 1.0 | 5 |

GRAPHS









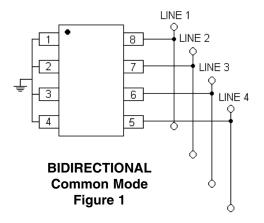
APPLICATION NOTES

Electronic equipment is susceptible to damage caused by Electrostatic Discharge (ESD), Electrical Fast Transients (EFT), and tertiary lightning effects. Knowing that equipment can be damaged, the SLVDA2.8LC was designed to provide the level of protection required to safe guard sensitive high speed data circuits. This product can be used to provide a level of protection to meet bidirectional requirements either in a common mode or differential mode configuration.

BIDIRECTIONAL COMMON MODE CONFIGURATION (Figure 1)

The SLVDA2.8LC can provide up to four (4) lines of protection in a common mode configuration as depicted in Figure 1. Circuit connectivity is as follows:

- " Line 1 is connected to pin 8,
- " Line 2 is connected to pin 7
- " Line 3 is connected to pin 6,
- " Line 4 is connected to pin 5.
- " Pins 1,2,3, and 4 are connected to ground

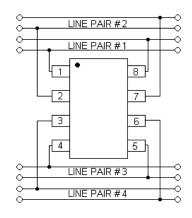


BIDIRECTIONAL DIFFERENTIAL MODE CONFIGURATION (Figure 2)

The SLVDA2.8LC can provide up to four line pairs (4) of protection in a differential mode configuration as depicted in Figure 2.

Circuit connectivity is as follows;

- " Line Pair # 1 is connected to pin 8 and 1.
- " Line Pair # 2 is connected to pin 7 and 2,
- " Line Pair # 3 is connected to pin 5 and 4,
- " Line Pair # 4 is connected to pin 6 and 3.



BIDIRECTIONAL Differential Mode Figure 2

PACKAGE OUTLINE & DIMENSIONS

PACKAGE OUTLINE (0.010" (0.25 MM) (M) B (M) (+) 0.010" (0.25 MM) (M) T B (S) A (S)

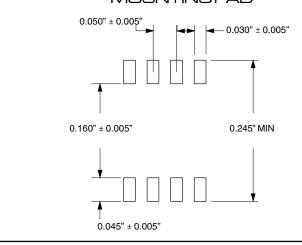
SO-8



PACKAGE DIMENSIONS

| | MILLIMI | ETERS | INCHES | | |
|-----|----------|----------|----------|----------|--|
| DIM | MIN | MAX | MIN | MAX | |
| Α | 4.80 | 5.00 | 0.189 | 0.196 | |
| В | 3.80 | 4.00 | 0.150 | 0.157 | |
| С | 1.35 | 1.75 | 0.054 | 0.068 | |
| D | 0.35 | 0.49 | 0.014 | 0.019 | |
| F | 0.40 | 1.250 | 0.016 | 0.049 | |
| G | 1.27 BSC | 1.27 BSC | 0.05 BSC | 0.05 BSC | |
| J | 0.18 | 0.25 | 0.007 | 0.009 | |
| K | 0.10 | 0.25 | 0.004 | 0.008 | |
| Р | 5.80 | 6.20 | 0.229 | 0.244 | |
| R | 0.25 | 0.50 | 0.010 | 0.019 | |

MOUNTINGPAD



- 1. T = Seating Plane and Datum Surface.
- Dimensions "A" and "B" are Datum.
 Dimensions "A" and "B" do not include mold protrusion.
- 4. Maximum mold protrusion is 0.015" (0.380 mm) per side.
- 5. Dimensioning and tolerances per ANSI Y14.5M,
- 6. Dimensions are exclusive of mold flash and metal burrs.

06009 Rev 1 -11/01

TAPE & REEL PACKAGING:

Surface mount product is taped and reeled in accordance with EIA-481, reel quantites and sizes are as follows:

7 Inch Reel - 1,000 pieces per reel; 13 Inch Reel - 2,500 pieces per reel

ProTek Devices

2929 South Fair Lane, Tempe, AZ 85282 Tel: 602-431-8101 Fax: 602-431-2288

E-Mail: sales@protek-tvs.com Web Site: www.protekdevices.com

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